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www.vishay.com

Vishay Semiconductors

## **Thyristor Surface Mount, Phase Control SCR, 16 A**



D <sup>2</sup> PAK		っつにろり	Ð١
D-PAR	LIO.	-ZUJA	

PRIMARY CHARACTERISTICS						
I <sub>T(AV)</sub> 16 A						
$V_{DRM}/V_{RRM}$	1600 V					
$V_{TM}$	1.25 V					
I <sub>GT</sub>	45 mA					
$T_J$	-40 to +125 °C					
Package	D <sup>2</sup> PAK (TO-263AB)					
Circuit configuration	Single SCR					

#### **FEATURES**

 Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C



 Designed and qualified according JEDEC®-JESD 47

 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- · Input rectification (soft start)
- Vishay input diodes, switches and output rectifiers which are available in identical package outlines

#### **DESCRIPTION**

The VS-25TTS16S-M3 of silicon controlled rectifiers is specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS						
APPLICATIONS	SINGLE-PHASE BRIDGE	THREE-PHASE BRIDGE	UNITS			
NEMA FR-4 or G10 glass fabric-based epoxy with 4 oz. (140 µm) copper	3.5	5.5				
Aluminum IMS, R <sub>thCA</sub> = 15 °C/W	8.5	13.5	A			
Aluminum IMS with heatsink, R <sub>thCA</sub> = 5 °C/W	16.5	25.0				

#### Note

•  $T_A = 55$  °C,  $T_J = 125$  °C, footprint 300 mm<sup>2</sup>

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
I <sub>T(AV)</sub>	Sinusoidal waveform	16	۸		
I <sub>RMS</sub>		25	А		
V <sub>RRM</sub> /V <sub>DRM</sub>		1600	V		
I <sub>TSM</sub>		350	Α		
$V_{T}$	16 A, T <sub>J</sub> = 25 °C	1.25	V		
dV/dt		500	V/µs		
dl/dt		150	A/µs		
T <sub>J</sub>		-40 to +125	°C		

<b>VOLTAGE RATINGS</b>			
PART NUMBER	V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V	V <sub>DRM</sub> , MAXIMUM PEAK DIRECT VOLTAGE V	I <sub>RRM</sub> /I <sub>DRM</sub> , AT 125 °C mA
VS-25TTS16S-M3	1600	1600	10



ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEC	VAL	UNITS				
PARAMETER	STINIBUL	TEST CONDITIONS		TYP.	MAX.	UNITS		
Maximum average on-state current	I <sub>T(AV)</sub>	T <sub>C</sub> = 93 °C, 180° c	onduction half sine wave	1	6			
Maximum RMS on-state current	I <sub>RMS</sub>			2	:5	Α		
Maximum peak, one-cycle,		10 ms sine pulse, r	rated V <sub>RRM</sub> applied	30	00	^		
non-repetitive surge current	I <sub>TSM</sub>	10 ms sine pulse, r	no voltage reapplied	3	50			
Maximum I <sup>2</sup> t for fusing	I <sup>2</sup> t	10 ms sine pulse, r	rated V <sub>RRM</sub> applied	4	50	A <sup>2</sup> s		
Maximum 1-t for fusing	1-1	10 ms sine pulse, r	63	30	A-5			
Maximum I <sup>2</sup> √t for fusing	I <sup>2</sup> √t	t = 0.1 ms to 10 ms	s, no voltage reapplied	63	00	A²√s		
Maximum on-state voltage drop	$V_{TM}$	16 A, T <sub>J</sub> = 25 °C			25	V		
On-state slope resistance	r <sub>t</sub>	T 405.00			2.0	mΩ		
Threshold voltage	V <sub>T(TO)</sub>	T <sub>J</sub> = 125 °C		1	.0	V		
Maximum reverse and direct leakage current	l/l	T <sub>J</sub> = 25 °C	V= = rated V= Λ/	0.5				
Maximum reverse and direct leakage current	I <sub>RM</sub> /I <sub>DM</sub>	T <sub>J</sub> = 125 °C	V <sub>R</sub> = rated V <sub>RRM</sub> /V <sub>DRM</sub>	1	0			
Holding current	I <sub>H</sub>	Anode supply = 6 V, resistive load, initial $I_T$ = 1 A, $T_J$ = 25 °C		-	150	mA		
Maximum latching current	ΙL	Anode supply = 6 V, resistive load, T <sub>J</sub> = 25 °C		Anode supply = 6 V, resistive load, T <sub>J</sub> = 25 °C		20	00	
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J \text{ max., linear}$	r to 80 %, V <sub>DRM</sub> = R <sub>g</sub> - k = open	50	00	V/µs		
Maximum rate of rise of turned-on current	dl/dt			1:	50	A/µs		

TRIGGERING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum peak gate power	P <sub>GM</sub>		8.0	W
Maximum average gate power	P <sub>G(AV)</sub>		2.0	VV
Maximum peak positive gate current	+ I <sub>GM</sub>		1.5	Α
Maximum peak negative gate voltage	- V <sub>GM</sub>		10	V
		Anode supply = 6 V, resistive load, T <sub>J</sub> = -10 °C	60	
Maximum required DC gate current to trigger	I <sub>GT</sub>	Anode supply = 6 V, resistive load, T <sub>J</sub> = 25 °C	45	mA
		Anode supply = 6 V, resistive load, T <sub>J</sub> = 125 °C	20	
		Anode supply = 6 V, resistive load, T <sub>J</sub> = -10 °C	2.5	
Maximum required DC gate voltage to trigger	$V_{GT}$	Anode supply = 6 V, resistive load, T <sub>J</sub> = 25 °C	2.0	V
		Anode supply = 6 V, resistive load, T <sub>J</sub> = 125 °C	1.0	V
Maximum DC gate voltage not to trigger	$V_{GD}$	T 105 °C V reted value	0.25	
Maximum DC gate current not to trigger	$I_{GD}$	$T_J = 125$ °C, $V_{DRM} = $ rated value 2.0		mA

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Typical turn-on time	t <sub>gt</sub>	T <sub>J</sub> = 25 °C	0.9	
Typical reverse recovery time	t <sub>rr</sub>	T <sub>.1</sub> = 125 °C	4	μs
Typical turn-off time	t <sub>q</sub>	1J = 125 C	110	



THERMAL AND MECHANICA PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-40 to +125	°C
Maximum thermal resistance, junction to case	R <sub>thJC</sub>	DC operation	1.1	°C/W
Typical thermal resistance, junction to ambient (PCB mount)	R <sub>thJA</sub> <sup>(1)</sup>		40	C/VV
Approximate weight			2	g
Approximate weight			0.07	OZ.
Marking device		Case style D <sup>2</sup> PAK (TO-263AB)	25TT	S16S

#### Note

<sup>(1)</sup> When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm] copper 40 °C/W. For recommended footprint and soldering techniques refer to application note #AN-994

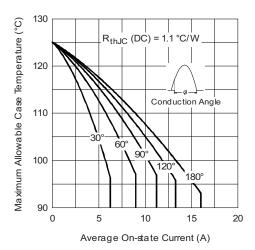


Fig. 1 - Current Rating Characteristics

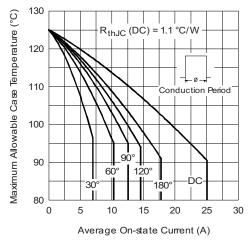


Fig. 2 - Current Rating Characteristics

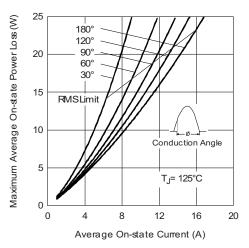


Fig. 3 - On-State Power Loss Characteristics

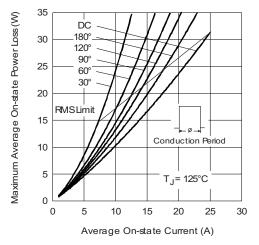


Fig. 4 - On-State Power Loss Characteristics

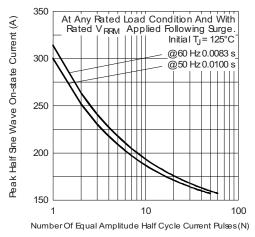


Fig. 5 - Maximum Non-Repetitive Surge Current

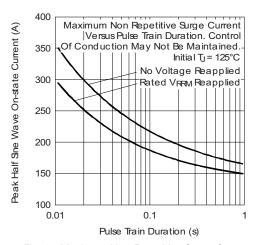


Fig. 6 - Maximum Non-Repetitive Surge Current

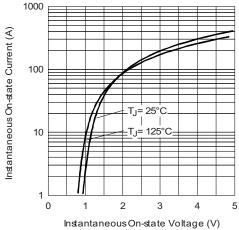


Fig. 7 - On-State Voltage Drop Characteristics

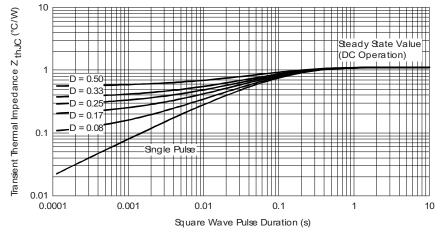


Fig. 8 - Gate Characteristics

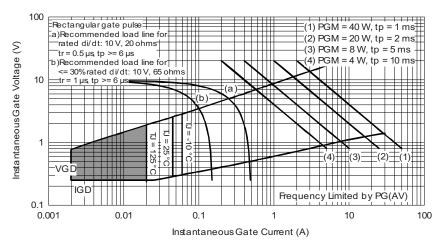


Fig. 9 - Thermal Impedance  $Z_{thJC}$  Characteristics

### **ORDERING INFORMATION TABLE**

Device code	VS-	25	Т	т	s	16	s	TRL	-M3
	1	2	3	4	5	6	7	8	9
	1	- Visl	hay Sen	nicondu	ctors pro	oduct			
	2	- Cur	rent rati	ng (25 =	= 25 A)				
	3		cuit conf	iguration	n:				
	4	- Pac	kage:	(TO-26	BAR)				
	5		e of sili	•	,				
	6			rd recov ing: Volt	•		= V <sub>RRI</sub>	и ——	16 = 1
	7	- S=	surface	mounta	able				
	8	- • No	one = tu	be					
				e and re be and r	`		,		
	9	M3	s = halog	gen-free	, RoHS	-complia	ant, and	termina	ations le

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-25TTS16S-M3	50	1000	Antistatic plastic tubes			
VS-25TTS16STRR-M3	800	800	13" diameter reel			
VS-25TTS16STRL-M3	800	800	13" diameter reel			

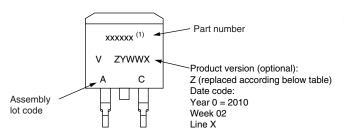
LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?96164				
Part marking information	www.vishay.com/doc?95444				
Packaging information	www.vishay.com/doc?96424				



# **Part Marking Information**

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### D<sup>2</sup>PAK



Example: This is a xxxxxx <sup>(1)</sup> with assembly lot code AC, assembled on WW 02, 2010

#### Note

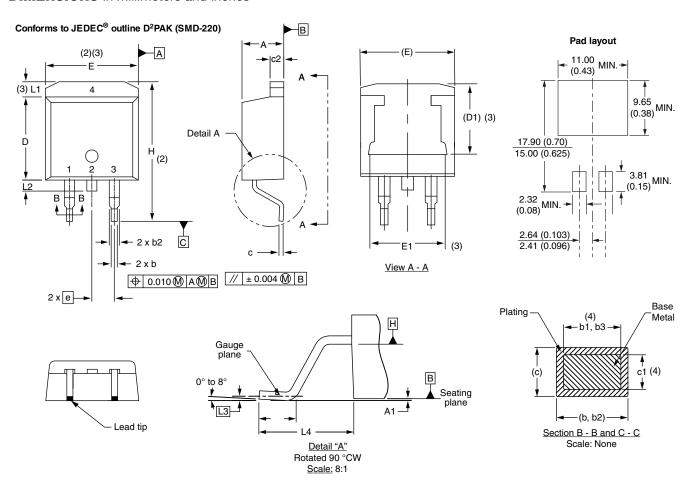
(1) If part number contain "H" as last digit, product is AEC-Q101 qualified

ENVIRONMENTAL NAMING CODE (Z)	PRODUCT DEFINITION			
A	Termination lead (Pb)-free			
В	Totally lead (Pb)-free			
E	RoHS-compliant and termination lead (Pb)-free			
F	RoHS-compliant and totally lead (Pb)-free			
М	Halogen-free, RoHS-compliant, and termination lead (Pb)-free			
N	Halogen-free, RoHS-compliant, and totally lead (Pb)-free			
G	Green			



## D<sup>2</sup>PAK

### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	NOTES	STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190		D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010		E	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039		E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4	е	2.54 BSC		0.100 BSC		
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4	L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4	L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065		L3	0.25 BSC		0.010 BSC		
D	8.51	9.65	0.335	0.380	2	L4	4.78	5.28	0.188	0.208	

#### Notes

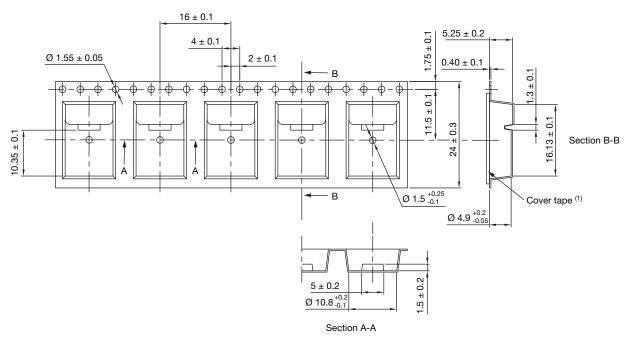
- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

Revision: 13-Jul-17 Document Number: 96164



# D<sup>2</sup>PAK (TO-263AB)

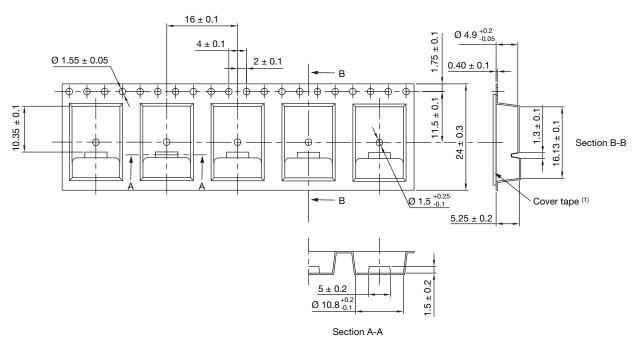
### **CARRIER TAPE FOR TAPE AND REEL LEFT** in millimeters



#### Note

(1) For dimensions, see next pages

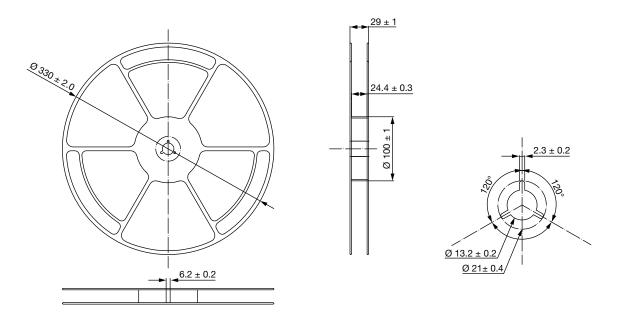
### **CARRIER TAPE FOR TAPE AND REEL RIGHT** in millimeters



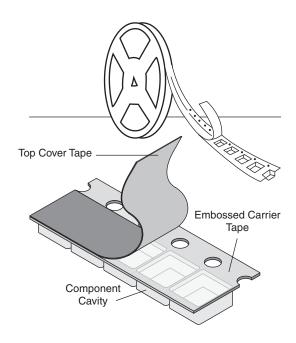
### Note

(1) For dimensions, see next pages

### **REEL FOR CARRIER TAPE** in millimeters



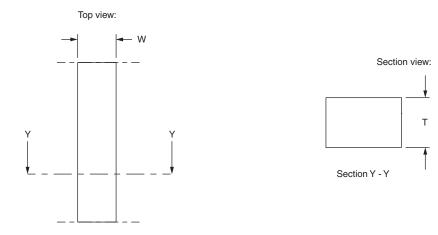
### CARRIER TAPE AND REEL PACKAGING D<sup>2</sup>PAK (TO-263AB)



# **Packaging Information**

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### **COVER TAPE FOR CARRIER TAPE** in millimeters



APPLICATION	COVER TAPE WIDTH W	COVER TAPE THICKNESS T	CARRIER TAPE WIDTH	MATERIAL
D <sup>2</sup> PAK (TO-263AB)	21.3 ± 0.1	0.060 ± 0.01	24	Antistatic/treated/transparent/polyester



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